imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

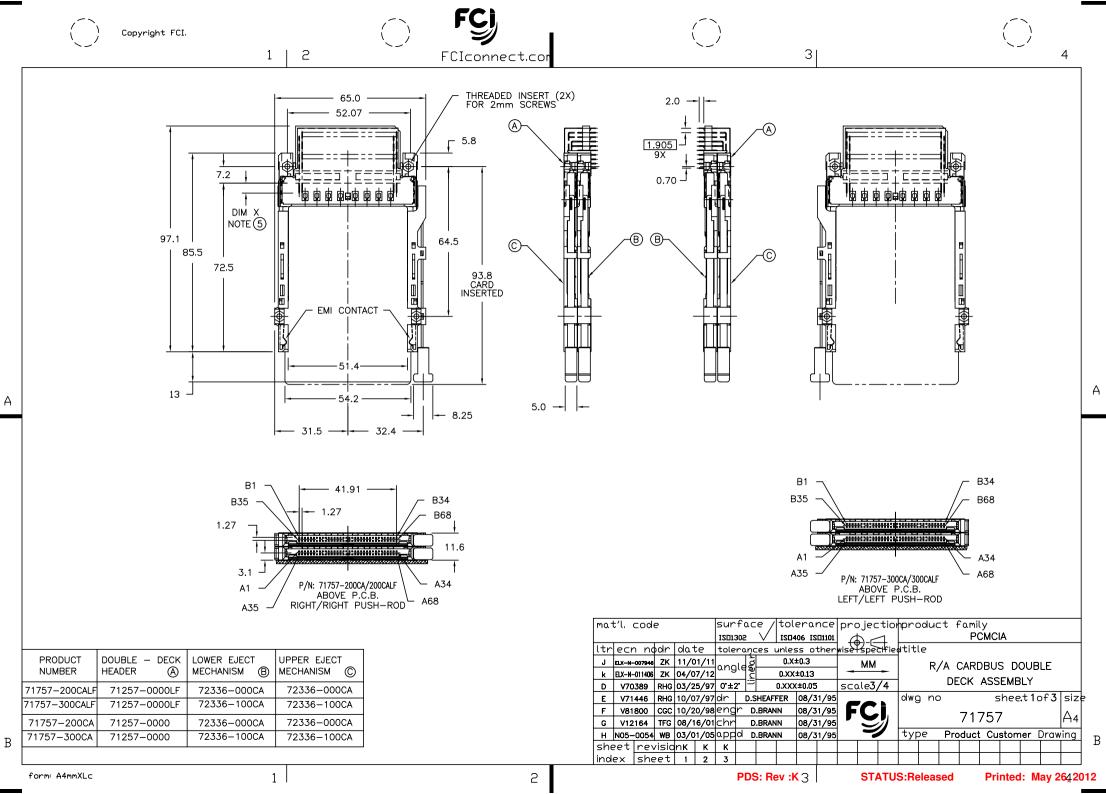
We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

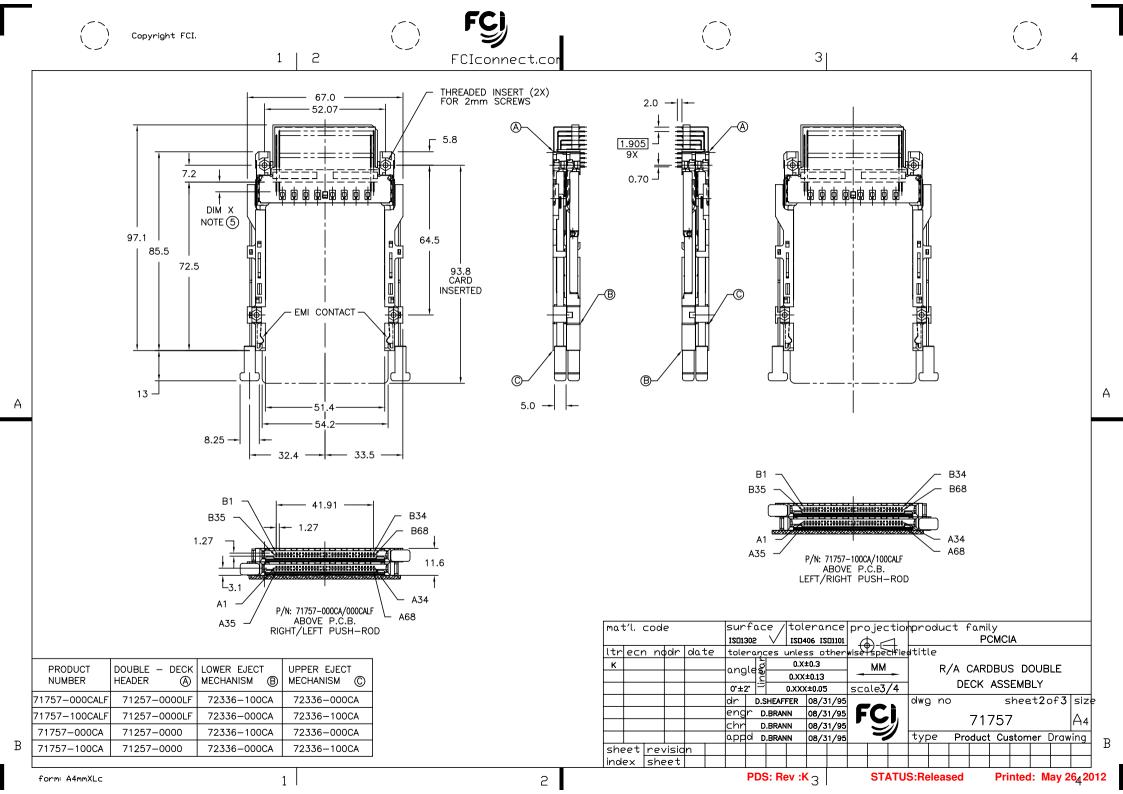


Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

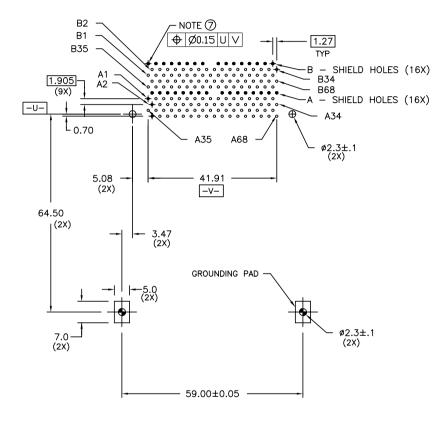






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FCIconnect.com



NOTES:

- 1 8mm MIN CARD EJECT.
- 2 EJECT TRAVEL: 9.5mm
- 3 MATERIAL:
 - 3.1 HEADER ASSY: HOUSING: HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK PIN: COPPER ALLOY
 - 3.2 EJECT MECHANISM ASSY: HOUSING: HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK COVER PLATE, EJECT PLATE, LINK ARM, PUSH ROD: STAINLESS STEEL EMI CONTACT: PHOSPHOR BRONZE
- 4 FINISH (PIN) UNDER PLATING: 0.5um Ni CONTACT AREA: 0.076 μm MIN. GOLD

SOLDER TAIL(TIN LEAD OPTION): 2.5 μ m Sn-Pb SOLDER TAIL(LEAD FREE OPTION): 2.5 μ m PURE TIN

- DIM "X" 4.25±0.1 3.5±0.1 5.0±0.1
 PIN NUMBER OTHERS 36,67 1,17,34,35,51,68
 RECOMMENDED SCREW TORQUE: 1.0 TO

 MAX in-lbs. (1.2-1.7 cm-kgs).
 RECOMMENDED HOLD DOWN: 2mm SCREWS AND NUTS
- (7) SEE 95121 AND 92869 FOR INFORMATION. RECOMMENDED DIAMETER IS \$\vert\$1.0. FOR PROCESSES USING PASTE REFLOW, HOLE MAY BE AS SMALL AS \$\vert\$0.79.
- (8) IF LEAD FREE P.N.THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD.
- (9) IF LEAD FREE P/N.THE PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DISCRIBLED IN GS-22-008
- (10) LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION
- 11 PRODUCT SPEC: 110-263

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PDS: Rev :K³

STATUS:Released

Printed: May 26